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NATIONAL STANDARD OF THE

PEOPLE'S REPUBLIC OF CHINA

GB/T 17574.8-2026

Semiconductor devices-Integrated circuits-Part 2-8:Digital integrated circuits-Blank detail specification for integrated circuits static read/write memories

半导体器件 集成电路 第2-8部分：数字集成电路 集成电路静态读/写存储器空白详细规范

(English Translation)

Issued on: October 30, 2026 **Implemented on: May 1, 2027**

Issued by: State Administration for Market Regulation;
Standardization Administration of China

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https://chinastandards.org/standards/gb-t-17574-8-2026

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1 Foreword

GB/T 17574.8-2026 was issued by State Administration for Market Regulation; Standardization Administration of China on 30 October 2026 and takes effect on 1 May 2027.

It is one of 7 parts of the GB/T 17574 series.

The GB/T prefix marks a recommended standard. It is not law in itself: it becomes binding when a contract names it, when a regulation or a mandatory standard refers to it, or when a producer declares conformity with it.

2 Scope Preview

GB/T 17574.8-2026 carries no ICS number and no Chinese Standard Classification code.

This catalogue holds 76,457 other GB/T standards.

Of the 47,415 GB/T standards that do carry an ICS number, 3,437 (7%) fall under ICS 77, in the field of metallurgy.

3 About this standard

Issued by: State Administration for Market Regulation; Standardization Administration of China

4 Related standards

Other parts of this standard:

GB/T 17574-1998 - Semiconductor devices. Integrated circuits. Part 2: Digital integrated circuits

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GB/T 17574.6-2026 - Semiconductor devices-Integrated circuits-Part 2-6:Digital integrated circuits-Blank detail specification for microprocessor

GB/T 17574.9-2006 - Semiconductor devices -- Integrated circuits -- Part 2-9: Digital integrated circuits -- Blank detail specification for MOS ultraviolet light erasable electrically programmable read-only memories

GB/T 17574.10-2003 - Semiconductor devices -- Integrated circuits -- Part 2-10: Digital integrated circuits -- Blank detail specification for integrated circuit dynamic read/write memories

GB/T 17574.11-2006 - Semiconductor devices -- Integrated circuits -- Part 2-11: Digital integrated circuits -- Blank detail specification for single supply integrated circuit electrically erasable and programmable read-only memory

GB/T 17574.20-2006 - Semiconductor devices -- Integrated circuits -- Part 2-20: Digital integrated circuits -- Family specification -- Low voltage integrated circuits

5 Classification and status

Prefix GB/T: recommended standard.

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